

Packaging Bio-amplifiers to Monitor Extra-cellular Activity

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Cell Clinics Project Overview

Integrated on-chip biolab systems designed to capture, contain, and analyze individual cells and their electrical, biochemical and other various properties.



Custom VLSI bio-amplifier designed for low voltage operation amplifies weak extracellular electrical signals from on-chip electrodes. Other custom sensors and systems such as imagers, capacitance sensors, dielectrophoresis arrays, and potentiostats are in development.

>Devices fabricated through the MOSIS integrated circuit fabrication service using a commercial CMOS process.

>On-chip MEMS lidded microvials with actuated hinges close upon capture of cell by responding to electrochemical potential. Microvials contain sensors to monitor cell activity.

➢Potential applications in medicine, physiology, individual cells studies, environmental monitoring, biomedical implants, and remote bio sensing.

vial inge-Bioamptifier

Biocompatibility Study

➢Biocompatibility of different silicones used for injection molding must be determined as they will be in direct contact with cells. Non-biocompatible materials will harm the cells and adversely affect measurements.

Experimental Procedure

>2 Polytek[™] silicones tested

>4 silicone rings of each type formed by filling liquid silicone into a 9-hole mold block (see insert).

>2x4 silicone rings inserted into 8 wells in multi-well plate. 8 control left empty. All wells seeded with 3500 cells/cm² of BASMC and allowed to grow for 10 days with every other day monitoring and changing of cell growth medium.

>Cell confluence levels in each well estimated by averaging measurements of cell densities

microscope.

Results

>S1: not biocompatible S2: biocompatible; 95%, 98% statistical significance levels.

>Very little intra-experiment variation: cells in different wells

Custom Chip Packaging

Why package bio-labs-on-a-chip?

>Protect cells in growth medium from toxic packaging materials in the 40pin DIP chip package, since cell environment is on the surface of the chip.

Isolate and insulate exposed bondwires in 40-pin DIP chip package from corrosive materials in the cell environment. Injection molding packaging method



Bio-amplifier electrodes are electrolessly plated with gold because aluminum bioelectronic interfaces suffer corrosion in the cell environment and is not biocompatible, and to decrease noise

Custom packaging assembly built to allow injected silicone material to form around the chip, creating a well to contain the cell solution, and insulating and encapsulating the bondwires.

>Assembly has 3-axis micromanipulators and rotational manipulator for alignment and injection. Curing can be done directly on PCB circuit board.

Packaging issues include protecting delicate bondwires in the chip package that are easily detached or shorted, and providing a watertight



Long Term Monitoring Setup



Fixture w/bio-amplifier circuit and live cells (in incubator) connected to PCMCIA data acquisition card in laptop PC with external hard disk for data streaming.

>Designed for long term (>24 hours), continuous monitoring.

>Matlab™ program designed to acquire, record, and display extra-cellular voltages from cells through the bio-amplifier, and to detect, and display voltage potential spike events in recorded data or real time through graphical user interface.

Summary

 Proved watertight seal of silicon mold/chip passivation layer interface.
Successful encapsulation and insulation of bondwires.
Minimal variation between two different trials using the packaging assembly.



Future Work

Reduce variation in the packaging process, and determine biocompatibility of more silicones.

>Package Bio-amplifiers w/MEMS structures chip for testing and long term recordings for extra-cellular activity.

Package other Cell Clinics sensors that require a stable bioelectronic interface such as imagers, capacitance sensors, and dielectrophoresis arrays. Acknowledgements

Thanks to Dr. Pamela Abshire of the Dept. of Electrical and Computer Eng., Erik Rencs of Microcosm Inc., Joanna Wong of ISR/REU, Graduate Students of the IBIS Lab in the Dept. of Electrical and Computer Eng., Dr. Judi Bell and Linda Allen of the Dept. of Electrical and Computer Eng. and the MERIT Program, and Yingkai Liu of the Dept. of Mechanical Eng.